

## LMP8645、LMP8645HV 高压电流检测精密放大器

### 1 特性

- 典型值,  $T_A = 25^\circ\text{C}$
- 高共模电压范围
  - LMP8645 - 2V 至 42V
  - LMP8645HV - 2V 至 76V
- 电源电压范围: 2.7V 至 12V
- 可通过单个电阻器配置增益
- 最大可变增益精度 (使用外部电阻器) 为 2%
- 跨导:  $200\ \mu\text{A/V}$
- 低失调电压  $1\text{mV}$
- 输入偏置  $12\ \mu\text{A}$
- PSRR 90dB
- CMRR 95dB
- 温度范围:  $-40^\circ\text{C}$  至  $125^\circ\text{C}$
- 6 引脚 SOT 封装

### 2 应用

- 高侧电流感测
- 车辆电流测量
- 电机控制
- 电池监控
- 远程感应
- 电源管理

### 3 说明

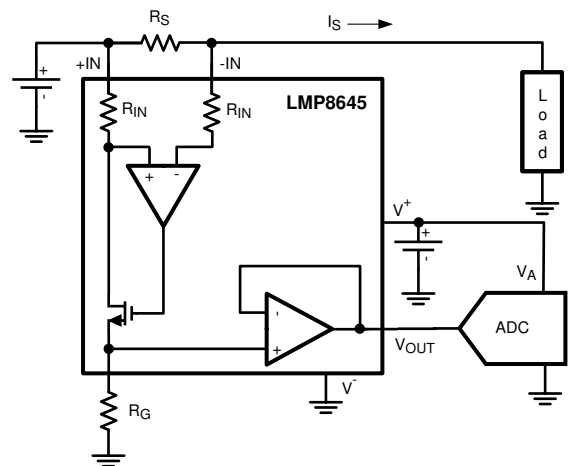
LMP8645 和 LMP8645HV 器件是精密电流检测放大器, 可在高输入共模电压条件下检测到检测电阻上的小差分电压。

LMP8645 在 2.7V 至 12V 的电源电压范围内工作, 可接受 - 2V 至 42V 共模电压范围内的输入信号, 而 LMP8645HV 可接受 - 2V 至 76V 共模电压范围内的输入信号。LMP8645 和 LMP8645HV 具有可调增益, 适用于电源电流和高共模电压起决定性作用的应用。增益由单个电阻器配置, 可提供高度灵活性, 以及低至 2% (最大值) 的精度 (增益设置电阻器的精度也是如此)。输出经缓冲可提供低输出阻抗。这款高侧电流检测放大器非常适合检测和监控直流或电池供电系统中的电流, 在整个温度范围内具有出色的交流和直流规格, 并可将电流检测环路中的误差保持在最低水平。LMP8645 是工业、汽车和消费类应用的理想选择, 采用 SOT-6 封装。

#### 器件信息<sup>(1)</sup>

| 器件型号      | 封装      | 封装尺寸 (标称值)      |
|-----------|---------|-----------------|
| LMP8645   | SOT (6) | 1.60mm × 2.90mm |
| LMP8645HV |         |                 |

(1) 如需了解所有可用封装, 请参阅数据表末尾的可订购产品附录。



典型应用



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## 4 Revision History

注：以前版本的页码可能与当前版本的页码不同

|                                                                                                                                                                                                             |             |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------|
| <b>Changes from Revision G (September 2015) to Revision H (May 2022)</b> .....                                                                                                                              | <b>Page</b> |
| • 更新了整个文档中的表格、图和交叉参考的编号格式.....                                                                                                                                                                              | 1           |
| • Removed <i>Absolute Maximum Ratings</i> tablenote: If Military/Aerospace specified devices are required, contact the Texas Instruments Sales Office/Distributors for availability and specifications..... | 3           |
| <b>Changes from Revision F (March 2013) to Revision G (September 2015)</b> .....                                                                                                                            | <b>Page</b> |
| • 添加了 <i>ESD</i> 等级表、特性说明部分、器件功能模式、应用和实施部分、电源相关建议部分、布局部分、器件和文档支持部分以及机械、封装和可订购信息部分.....                                                                                                                      | 1           |
| <b>Changes from Revision E (March 2013) to Revision F (March 2013)</b> .....                                                                                                                                | <b>Page</b> |
| • Changed layout of National Data Sheet to TI format.....                                                                                                                                                   | 22          |

## 5 Pin Configuration and Functions

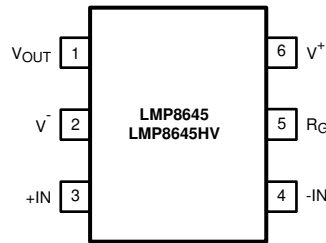


图 5-1. DD Package 6-Pin SOT Top View

表 5-1. Pin Functions

| PIN              |     | I/O | DESCRIPTION             |
|------------------|-----|-----|-------------------------|
| NAME             | NO. |     |                         |
| V <sub>OUT</sub> | 1   | O   | Single-ended output     |
| V <sup>-</sup>   | 2   | P   | Negative supply voltage |
| +IN              | 3   | I   | Positive input          |
| -IN              | 4   | I   | Negative input          |
| R <sub>G</sub>   | 5   | I/O | External gain resistor  |
| V <sup>+</sup>   | 6   | P   | Positive supply voltage |

## 6 Specifications

### 6.1 Absolute Maximum Ratings

See (1) (2) (3)

|                                       |           | MIN            | MAX            | UNIT |
|---------------------------------------|-----------|----------------|----------------|------|
| Supply Voltage ( $V_S = V^+ - V^-$ )  |           |                | 13.2           | V    |
| Differential voltage +IN- (-IN)       |           |                | 6              | V    |
| Voltage at pins +IN, -IN              | LMP8645HV | - 6            | 80             | V    |
|                                       | LMP8645   | - 6            | 60             | V    |
| Voltage at R <sub>G</sub> pin         |           |                | 13.2           | V    |
| Voltage at OUT pin                    |           | V <sup>-</sup> | V <sup>+</sup> | V    |
| Junction temperature <sup>(2)</sup>   |           |                | 150            | °C   |
| Storage temperature, T <sub>stg</sub> |           | - 65           | 150            | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The maximum power dissipation must be derated at elevated temperatures and is dictated by T<sub>J(MAX)</sub>, R<sub>θJA</sub>, and the ambient temperature, T<sub>A</sub>. The maximum allowable power dissipation P<sub>DMAX</sub> = (T<sub>J(MAX)</sub> - T<sub>A</sub>) / R<sub>θJA</sub> or the number given in Absolute Maximum Ratings, whichever is lower.
- (3) For soldering specifications, refer to [SNOA549](#)

### 6.2 ESD Ratings

|                                            |                                                                                |                         | VALUE | UNIT |
|--------------------------------------------|--------------------------------------------------------------------------------|-------------------------|-------|------|
| V <sub>(ESD)</sub> Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/ JEDEC JS-001 <sup>(1) (3)</sup>         | All pins except 3 and 4 | ±2000 | V    |
|                                            |                                                                                | Pins 3 and 4            | ±5000 |      |
|                                            | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> |                         | ±1250 |      |
|                                            | Machine Model                                                                  |                         | ±200  |      |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.
- (3) Human Body Model, applicable std. MIL-STD-883, Method 3015.7. Machine Model, applicable std. JESD22-A115-A (ESD MM std. of JEDEC) Field-Induced Charge-Device Model, applicable std. JESD22-C101-C (ESD FICDM std. of JEDEC).

### 6.3 Recommended Operating Conditions

|                                      | MIN  | MAX | UNIT |
|--------------------------------------|------|-----|------|
| Supply voltage ( $V_S = V^+ - V^-$ ) | 2.7  | 12  | V    |
| Temperature range <sup>(1)</sup>     | - 40 | 125 | °C   |

- (1) The maximum power dissipation must be derated at elevated temperatures and is dictated by  $T_{J(MAX)}$ ,  $R_{\theta JA}$ , and the ambient temperature,  $T_A$ . The maximum allowable power dissipation  $P_{DMAX} = (T_{J(MAX)} - T_A) / R_{\theta JA}$  or the number given in Absolute Maximum Ratings, whichever is lower.

### 6.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup>                                         | LMV8645,<br>LMV8645HV | UNIT |
|-----------------------------------------------------------------------|-----------------------|------|
|                                                                       | DDC (SOT)             |      |
|                                                                       | 6 PINS                |      |
| $R_{\theta JA}$ Junction-to-ambient thermal resistance <sup>(2)</sup> | 96                    | °C/W |

- (1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, [SPRA953](#).
- (2) The maximum power dissipation must be derated at elevated temperatures and is dictated by  $T_{J(MAX)}$ ,  $R_{\theta JA}$ , and the ambient temperature,  $T_A$ . The maximum allowable power dissipation  $P_{DMAX} = (T_{J(MAX)} - T_A) / R_{\theta JA}$  or the number given in Absolute Maximum Ratings, whichever is lower.

## 6.5 2.7-V Electrical Characteristics

Unless otherwise specified, all limits specified for at  $T_A = 25^\circ\text{C}$ ,  $V_S = V^+ - V^-$ ,  $V^+ = 2.7\text{ V}$ ,  $V^- = 0\text{ V}$ ,  $-2\text{ V} < V_{CM} < 76\text{ V}$ ,  $R_G = 25\text{ k}\Omega$ ,  $R_L = 10\text{ M}\Omega$ .<sup>(1)</sup>

| PARAMETER         |                                                  | TEST CONDITIONS                                                                                                                                    |                             | MIN <sup>(3)</sup> | TYP <sup>(2)</sup> | MAX <sup>(3)</sup> | UNIT                         |
|-------------------|--------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------|--------------------|--------------------|--------------------|------------------------------|
| $V_{OS}$          | Input Offset Voltage                             | $V_{CM} = 2.1\text{ V}$                                                                                                                            |                             | -1                 |                    | 1                  | mV                           |
|                   |                                                  |                                                                                                                                                    | At the temperature extremes | -1.7               |                    | 1.7                |                              |
| $TCV_{OS}$        | Input Offset Voltage Drift <sup>(4)</sup><br>(6) | $V_{CM} = 2.1\text{ V}$                                                                                                                            |                             |                    |                    | 7                  | $\mu\text{V}/^\circ\text{C}$ |
| $I_B$             | Input Bias Current <sup>(7)</sup>                | $V_{CM} = 2.1\text{ V}$                                                                                                                            |                             |                    | 12                 | 20                 | $\mu\text{A}$                |
| $e_{ni}$          | Input Voltage Noise <sup>(6)</sup>               | $f > 10\text{ kHz}$ , $R_G = 5\text{ k}\Omega$                                                                                                     |                             |                    | 120                |                    | $\text{nV}/\sqrt{\text{Hz}}$ |
| $V_{SENSE(MA X)}$ | Max Input Sense Voltage <sup>(6)</sup>           | $V_{CM} = 12\text{ V}$ , $R_G = 5\text{ k}\Omega$                                                                                                  |                             |                    | 600                |                    | mV                           |
| Gain $A_V$        | Adjustable Gain Setting <sup>(6)</sup>           | $V_{CM} = 12\text{ V}$                                                                                                                             |                             | 1                  |                    | 100                | V/V                          |
| $G_m$             | Transconductance                                 | $V_{CM} = 2.1\text{ V}$                                                                                                                            |                             |                    | 200                |                    | $\mu\text{A/V}$              |
|                   | Accuracy                                         | $V_{CM} = 2.1\text{ V}$                                                                                                                            |                             | -2%                |                    | 2%                 |                              |
|                   |                                                  |                                                                                                                                                    | At the temperature extremes | -3.4%              |                    | 3.4%               |                              |
|                   | Gm drift <sup>(6)</sup>                          | $-40^\circ\text{C}$ to $125^\circ\text{C}$ , $V_{CM} = 2.1\text{ V}$                                                                               |                             |                    |                    | 140                | ppm/ $^\circ\text{C}$        |
| PSRR              | Power Supply Rejection Ratio                     | $V_{CM} = 2.1\text{ V}$ , $2.7\text{ V} < V^+ < 12\text{ V}$                                                                                       |                             | 90                 |                    |                    | dB                           |
| CMRR              | Common-Mode Rejection Ratio                      | LMP8645HV $2.1\text{ V} < V_{CM} < 76\text{ V}$<br>LMP8645 $2.1\text{ V} < V_{CM} < 42\text{ V}$                                                   |                             | 95                 |                    |                    | dB                           |
|                   |                                                  | $-2\text{ V} < V_{CM} < 2\text{ V}$                                                                                                                |                             | 60                 |                    |                    |                              |
| BW                | -3-dB Bandwidth <sup>(6)</sup>                   | $R_G = 10\text{ k}\Omega$ , $C_G = 4\text{ pF}$ , $V_{SENSE} = 400\text{ mV}$ ,<br>$C_L = 30\text{ pF}$ , $R_L = 1\text{ M}\Omega$                 |                             |                    | 990                |                    | kHz                          |
|                   |                                                  | $R_G = 25\text{ k}\Omega$ , $C_G = 4\text{ pF}$ , $V_{SENSE} = 200\text{ mV}$ ,<br>$C_L = 30\text{ pF}$ , $R_L = 1\text{ M}\Omega$                 |                             |                    | 260                |                    |                              |
|                   |                                                  | $R_G = 50\text{ k}\Omega$ , $C_G = 4\text{ pF}$ , $V_{SENSE} = 100\text{ mV}$ ,<br>$C_L = 30\text{ pF}$ , $R_L = 1\text{ M}\Omega$                 |                             |                    | 135                |                    |                              |
| SR                | Slew Rate <sup>(5)</sup> (6)                     | $V_{CM} = 5\text{ V}$ , $C_G = 4\text{ pF}$ , $V_{SENSE}$ from $25\text{ mV}$ to $175\text{ mV}$ , $C_L = 30\text{ pF}$ , $R_L = 1\text{ M}\Omega$ |                             |                    | 0.5                |                    | V/ $\mu\text{s}$             |
| $I_S$             | Supply Current                                   | $V_{CM} = 2.1\text{ V}$                                                                                                                            |                             |                    | 380                | 525                | $\mu\text{A}$                |
|                   |                                                  |                                                                                                                                                    | At the temperature extremes |                    |                    | 710                |                              |
|                   |                                                  | $V_{CM} = -2\text{ V}$                                                                                                                             |                             |                    | 2000               | 2500               |                              |
|                   |                                                  |                                                                                                                                                    | At the temperature extremes |                    |                    | 2700               |                              |
| $V_{OUT}$         | Maximum Output Voltage                           | $V_{CM} = 2.1\text{ V}$ , $R_G = 500\text{ k}\Omega$                                                                                               |                             | 1.2                |                    |                    | V                            |
|                   | Minimum Output Voltage                           | $V_{CM} = 2.1\text{ V}$                                                                                                                            |                             |                    |                    | 20                 | mV                           |
| $I_{OUT}$         | Output current <sup>(6)</sup>                    | Sourcing, $V_{OUT} = 600\text{ mV}$ , $R_G = 150\text{ k}\Omega$                                                                                   |                             |                    | 5                  |                    | mA                           |
|                   |                                                  | Sinking, $V_{OUT} = 600\text{ mV}$ , $R_G = 150\text{ k}\Omega$                                                                                    |                             |                    | 5                  |                    |                              |
| $C_{LOAD}$        | Max Output Capacitance Load <sup>(6)</sup>       |                                                                                                                                                    |                             |                    | 30                 |                    | pF                           |

- (1) Electrical Table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device such that  $T_J = T_A$ . No specification of parametric performance is indicated in the electrical tables under conditions of internal self-heating where  $T_J > T_A$ .
- (2) Typical values represent the most likely parametric norm at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration. The typical values are not tested and are not ensured on shipped production material.
- (3) All limits are specified by testing, design, or statistical analysis.
- (4) Offset voltage temperature drift is determined by dividing the change in  $V_{OS}$  at the temperature extremes by the total temperature change.
- (5) The number specified is the average of rising and falling slew rates and measured at 90% to 10%.
- (6) This parameter is specified by design and/or characterization and is not tested in production.

- (7) Positive Bias Current corresponds to current flowing into the device.

## 6.6 5-V Electrical Characteristics

Unless otherwise specified, all limits specified for at  $T_A = 25^\circ\text{C}$ ,  $V_S = V^+ - V^-$ ,  $V^+ = 5\text{ V}$ ,  $V^- = 0\text{ V}$ ,  $-2\text{ V} < V_{CM} < 76\text{ V}$ ,  $R_g = 25\text{ k}\Omega$ ,  $R_L = 10\text{ M}\Omega$ .<sup>(1)</sup>

| PARAMETER         |                                                  | TEST CONDITIONS                                                                                                                                     |                             | MIN <sup>(3)</sup> | TYP <sup>(2)</sup> | MAX <sup>(3)</sup> | UNIT                          |
|-------------------|--------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------|--------------------|--------------------|--------------------|-------------------------------|
| $V_{OS}$          | Input Offset Voltage                             | $V_{CM} = 2.1\text{ V}$                                                                                                                             |                             | -1                 |                    | 1                  | mV                            |
|                   |                                                  |                                                                                                                                                     | At the temperature extremes | -1.7               |                    | 1.7                |                               |
| $TCV_{OS}$        | Input Offset Voltage Drift <sup>(4)</sup><br>(6) | $V_{CM} = 2.1\text{ V}$                                                                                                                             |                             |                    |                    | 7                  | $\mu\text{ V}/^\circ\text{C}$ |
| $I_B$             | Input Bias Current <sup>(7)</sup>                | $V_{CM} = 2.1\text{ V}$                                                                                                                             |                             |                    | 12.5               | 22                 | $\mu\text{ A}$                |
| $e_{ni}$          | Input Voltage Noise <sup>(6)</sup>               | $f > 10\text{ kHz}$ , $R_G = 5\text{ k}\Omega$                                                                                                      |                             |                    | 120                |                    | $\text{nV}/\sqrt{\text{Hz}}$  |
| $V_{SENSE(MA X)}$ | Max Input Sense Voltage <sup>(6)</sup>           | $V_{CM} = 12\text{ V}$ , $R_G = 5\text{ k}\Omega$                                                                                                   |                             |                    | 600                |                    | mV                            |
| Gain $A_V$        | Adjustable Gain Setting <sup>(6)</sup>           | $V_{CM} = 12\text{ V}$                                                                                                                              |                             | 1                  |                    | 100                | V/V                           |
| $G_m$             | Transconductance                                 | $V_{CM} = 2.1\text{ V}$                                                                                                                             |                             |                    | 200                |                    | $\mu\text{ A/V}$              |
|                   | Accuracy                                         | $V_{CM} = 2.1\text{ V}$                                                                                                                             |                             | -2%                |                    | 2%                 |                               |
|                   |                                                  |                                                                                                                                                     | At the temperature extremes | -3.4%              |                    | 3.4%               |                               |
|                   | Gm drift <sup>(6)</sup>                          | $-40^\circ\text{C}$ to $125^\circ\text{C}$ , $V_{CM} = 2.1\text{ V}$                                                                                |                             |                    |                    | 140                | ppm/ $^\circ\text{C}$         |
| PSRR              | Power Supply Rejection Ratio                     | $V_{CM} = 2.1\text{ V}$ , $2.7\text{ V} < V^+ < 12\text{ V}$                                                                                        |                             | 90                 |                    |                    | dB                            |
| CMRR              | Common-Mode Rejection Ratio                      | LMP8645HV $2.1\text{ V} < V_{CM} < 76\text{ V}$<br>LMP8645 $2.1\text{ V} < V_{CM} < 42\text{ V}$                                                    |                             | 95                 |                    |                    | dB                            |
|                   |                                                  | $-2\text{ V} < V_{CM} < 2\text{ V}$                                                                                                                 |                             | 60                 |                    |                    |                               |
| BW                | -3-dB Bandwidth <sup>(6)</sup>                   | $R_G = 10\text{ k}\Omega$ , $C_G = 4\text{ pF}$ , $V_{SENSE} = 400\text{ mV}$ ,<br>$C_L = 30\text{ pF}$ , $R_L = 1\text{ M}\Omega$                  |                             |                    | 850                |                    | kHz                           |
|                   |                                                  | $R_G = 25\text{ k}\Omega$ , $C_G = 4\text{ pF}$ , $V_{SENSE} = 300\text{ mV}$ ,<br>$C_L = 30\text{ pF}$ , $R_L = 1\text{ M}\Omega$                  |                             |                    | 260                |                    |                               |
|                   |                                                  | $R_G = 50\text{ k}\Omega$ , $C_G = 4\text{ pF}$ , $V_{SENSE} = 300\text{ mV}$ ,<br>$C_L = 30\text{ pF}$ , $R_L = 1\text{ M}\Omega$                  |                             |                    | 140                |                    |                               |
| SR                | Slew Rate <sup>(5)</sup> (6)                     | $V_{CM} = 5\text{ V}$ , $C_G = 4\text{ pF}$ , $V_{SENSE}$ from $100\text{ mV}$ to $500\text{ mV}$ , $C_L = 30\text{ pF}$ , $R_L = 1\text{ M}\Omega$ |                             |                    | 0.5                |                    | V/ $\mu\text{s}$              |
| $I_S$             | Supply Current                                   | $V_{CM} = 2.1\text{ V}$                                                                                                                             |                             |                    | 450                | 610                | $\mu\text{ A}$                |
|                   |                                                  |                                                                                                                                                     | At the temperature extremes |                    |                    | 780                |                               |
|                   |                                                  | $V_{CM} = -2\text{ V}$                                                                                                                              |                             |                    | 2100               | 2800               |                               |
|                   |                                                  |                                                                                                                                                     | At the temperature extremes |                    |                    | 3030               |                               |
| $V_{OUT}$         | Maximum Output Voltage                           | $V_{CM} = 5\text{ V}$ , $R_g = 500\text{ k}\Omega$                                                                                                  |                             | 3.3                |                    |                    | V                             |
|                   | Minimum Output Voltage                           | $V_{CM} = 2.1\text{ V}$                                                                                                                             |                             |                    |                    | 22                 | mV                            |
| $I_{OUT}$         | Output current <sup>(6)</sup>                    | Sourcing, $V_{OUT} = 1.65\text{ V}$ , $R_g = 150\text{ k}\Omega$                                                                                    |                             |                    | 5                  |                    | mA                            |
|                   |                                                  | Sinking, $V_{OUT} = 1.65\text{ V}$ , $R_g = 150\text{ k}\Omega$                                                                                     |                             |                    | 5                  |                    |                               |
| $C_{LOAD}$        | Max Output Capacitance Load <sup>(6)</sup>       |                                                                                                                                                     |                             |                    | 30                 |                    | pF                            |

- (1) Electrical Table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device such that  $T_J = T_A$ . No specification of parametric performance is indicated in the electrical tables under conditions of internal self-heating where  $T_J > T_A$ .
- (2) Typical values represent the most likely parametric norm at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration. The typical values are not tested and are not ensured on shipped production material.
- (3) All limits are specified by testing, design, or statistical analysis.
- (4) Offset voltage temperature drift is determined by dividing the change in  $V_{OS}$  at the temperature extremes by the total temperature change.
- (5) The number specified is the average of rising and falling slew rates and measured at 90% to 10%.
- (6) This parameter is specified by design and/or characterization and is not tested in production.

- (7) Positive Bias Current corresponds to current flowing into the device.

## 6.7 12-V Electrical Characteristics

Unless otherwise specified, all limits specified for at  $T_A = 25^\circ\text{C}$ ,  $V_S = V^+ - V^-$ ,  $V^+ = 12\text{ V}$ ,  $V^- = 0\text{ V}$ ,  $-2\text{ V} < V_{CM} < 76\text{ V}$ ,  $R_g = 25\text{ k}\Omega$ ,  $R_L = 10\text{ M}\Omega$ .<sup>(1)</sup>

| PARAMETER         |                                                  | TEST CONDITIONS                                                                                                                                     |                             | MIN <sup>(3)</sup> | TYP <sup>(2)</sup> | MAX <sup>(3)</sup> | UNIT                         |
|-------------------|--------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------|--------------------|--------------------|--------------------|------------------------------|
| $V_{OS}$          | Input Offset Voltage                             | $V_{CM} = 2.1\text{ V}$                                                                                                                             |                             | -1                 |                    | 1                  | mV                           |
|                   |                                                  |                                                                                                                                                     | At the temperature extremes | -1.7               |                    | 1.7                |                              |
| $TCV_{OS}$        | Input Offset Voltage Drift <sup>(4)</sup><br>(6) | $V_{CM} = 2.1\text{ V}$                                                                                                                             |                             |                    |                    | 7                  | $\mu\text{V}/^\circ\text{C}$ |
| $I_B$             | Input Bias Current <sup>(7)</sup>                | $V_{CM} = 2.1\text{ V}$                                                                                                                             |                             |                    | 13                 | 23                 | $\mu\text{A}$                |
| $e_{ni}$          | Input Voltage Noise <sup>(6)</sup>               | $f > 10\text{ kHz}$ , $R_G = 5\text{ k}\Omega$                                                                                                      |                             |                    | 120                |                    | $\text{nV}/\sqrt{\text{Hz}}$ |
| $V_{SENSE(MA X)}$ | Max Input Sense Voltage <sup>(6)</sup>           | $V_{CM} = 12\text{ V}$ , $R_G = 5\text{ k}\Omega$                                                                                                   |                             |                    | 600                |                    | mV                           |
| Gain $A_V$        | Adjustable Gain Setting <sup>(6)</sup>           | $V_{CM} = 12\text{ V}$                                                                                                                              |                             | 1                  |                    | 100                | V/V                          |
| $G_m$             | Transconductance                                 | $V_{CM} = 2.1\text{ V}$                                                                                                                             |                             |                    | 200                |                    | $\mu\text{A/V}$              |
|                   | Accuracy                                         | $V_{CM} = 2.1\text{ V}$                                                                                                                             |                             | -2%                |                    | 2%                 |                              |
|                   |                                                  |                                                                                                                                                     | At the temperature extremes | -3.4%              |                    | 3.4%               |                              |
|                   | $G_m$ drift <sup>(6)</sup>                       | $-40^\circ\text{C}$ to $125^\circ\text{C}$ , $V_{CM} = 2.1\text{ V}$                                                                                |                             |                    |                    | 140                | ppm/ $^\circ\text{C}$        |
| PSRR              | Power Supply Rejection Ratio                     | $V_{CM} = 2.1\text{ V}$ , $2.7\text{ V} < V^+ < 12\text{ V}$                                                                                        |                             | 90                 |                    |                    | dB                           |
| CMRR              | Common-Mode Rejection Ratio                      | LMP8645HV $2.1\text{ V} < V_{CM} < 76\text{ V}$<br>LMP8645 $2.1\text{ V} < V_{CM} < 42\text{ V}$                                                    |                             | 95                 |                    |                    | dB                           |
|                   |                                                  | $-2\text{ V} < V_{CM} < 2\text{ V}$                                                                                                                 |                             | 60                 |                    |                    |                              |
| BW                | -3-dB Bandwidth <sup>(6)</sup>                   | $R_G = 10\text{ k}\Omega$ , $C_G = 4\text{ pF}$ , $V_{SENSE} = 400\text{ mV}$ ,<br>$C_L = 30\text{ pF}$ , $R_L = 1\text{ M}\Omega$                  |                             |                    | 860                |                    | kHz                          |
|                   |                                                  | $R_G = 25\text{ k}\Omega$ , $C_G = 4\text{ pF}$ , $V_{SENSE} = 400\text{ mV}$ ,<br>$C_L = 30\text{ pF}$ , $R_L = 1\text{ M}\Omega$                  |                             |                    | 260                |                    |                              |
|                   |                                                  | $R_G = 50\text{ k}\Omega$ , $C_G = 4\text{ pF}$ , $V_{SENSE} = 400\text{ mV}$ ,<br>$C_L = 30\text{ pF}$ , $R_L = 1\text{ M}\Omega$                  |                             |                    | 140                |                    |                              |
| SR                | Slew Rate <sup>(5)</sup> (6)                     | $V_{CM} = 5\text{ V}$ , $C_G = 4\text{ pF}$ , $V_{SENSE}$ from $100\text{ mV}$ to $500\text{ mV}$ , $C_L = 30\text{ pF}$ , $R_L = 1\text{ M}\Omega$ |                             |                    | 0.6                |                    | V/ $\mu\text{s}$             |
| $I_S$             | Supply Current                                   | $V_{CM} = 2.1\text{ V}$                                                                                                                             |                             |                    | 555                | 765                | $\mu\text{A}$                |
|                   |                                                  |                                                                                                                                                     | At the temperature extremes |                    |                    | 920                |                              |
|                   |                                                  | $V_{CM} = -2\text{ V}$                                                                                                                              |                             |                    | 2200               | 2900               |                              |
|                   |                                                  |                                                                                                                                                     | At the temperature extremes |                    |                    | 3110               |                              |
| $V_{OUT}$         | Maximum Output Voltage                           | $V_{CM} = 12\text{ V}$ , $R_G = 500\text{ k}\Omega$                                                                                                 |                             | 10.2               |                    |                    | V                            |
|                   | Minimum Output Voltage                           | $V_{CM} = 2.1\text{ V}$                                                                                                                             |                             |                    |                    | 24                 | mV                           |
| $I_{OUT}$         | Output current <sup>(6)</sup>                    | Sourcing, $V_{OUT} = 5.25\text{ V}$ , $R_g = 150\text{ k}\Omega$                                                                                    |                             |                    | 5                  |                    | mA                           |
|                   |                                                  | Sinking, $V_{OUT} = 5.25\text{ V}$ , $R_g = 150\text{ k}\Omega$                                                                                     |                             |                    | 5                  |                    |                              |
| $C_{LOAD}$        | Max Output Capacitance Load <sup>(6)</sup>       |                                                                                                                                                     |                             |                    | 30                 |                    | pF                           |

- (1) Electrical Table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device such that  $T_J = T_A$ . No specification of parametric performance is indicated in the electrical tables under conditions of internal self-heating where  $T_J > T_A$ .
- (2) Typical values represent the most likely parametric norm at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration. The typical values are not tested and are not ensured on shipped production material.
- (3) All limits are specified by testing, design, or statistical analysis.
- (4) Offset voltage temperature drift is determined by dividing the change in  $V_{OS}$  at the temperature extremes by the total temperature change.
- (5) The number specified is the average of rising and falling slew rates and measured at 90% to 10%.
- (6) This parameter is specified by design and/or characterization and is not tested in production.

- (7) Positive Bias Current corresponds to current flowing into the device.

## 6.8 Typical Characteristics

Unless otherwise specified:  $T_A = 25^\circ\text{C}$ ,  $V_S = V^+ - V^-$ ,  $V_{\text{SENSE}} = +\text{IN} - (-\text{IN})$ ,  $R_L = 10\text{ M}\Omega$ .

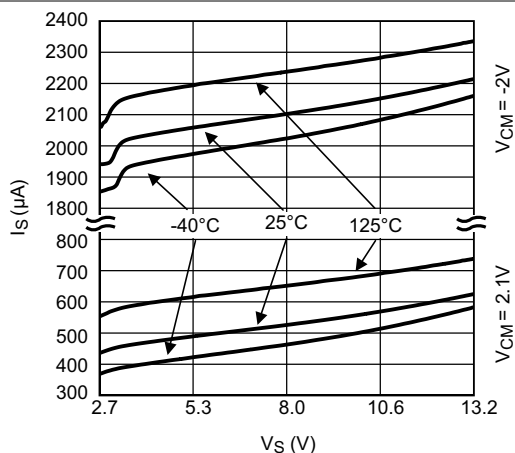


图 6-1. Supply Current vs. Supply Voltage

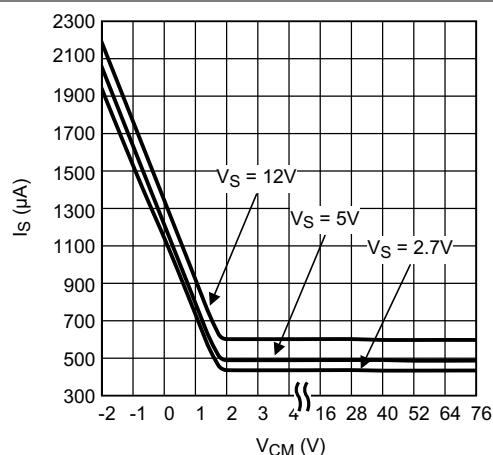


图 6-2. Supply Current vs.  $V_{\text{CM}}$

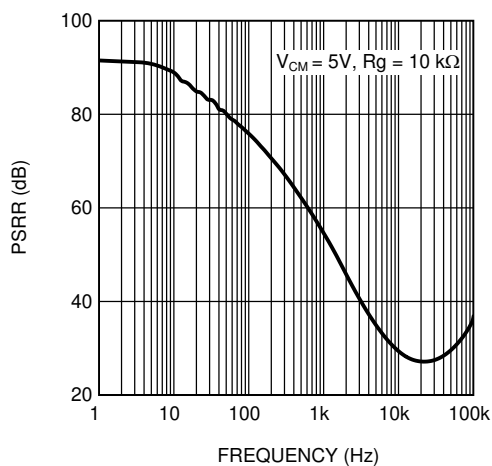


图 6-3. AC PSRR vs. Frequency

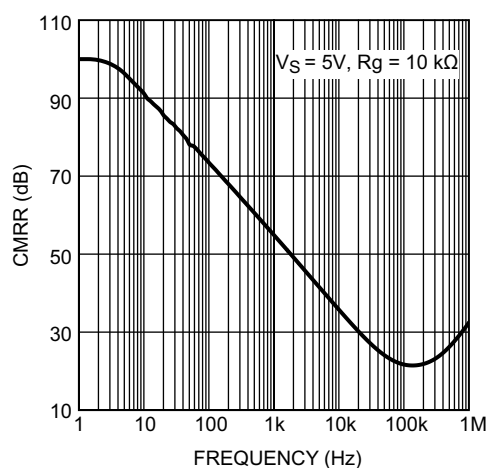


图 6-4. AC CMRR vs. Frequency

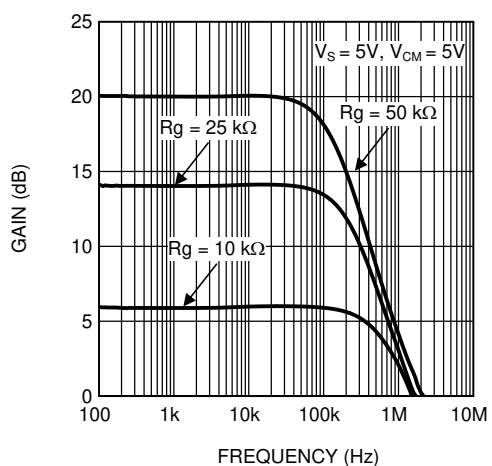


图 6-5. Gain vs. Frequency

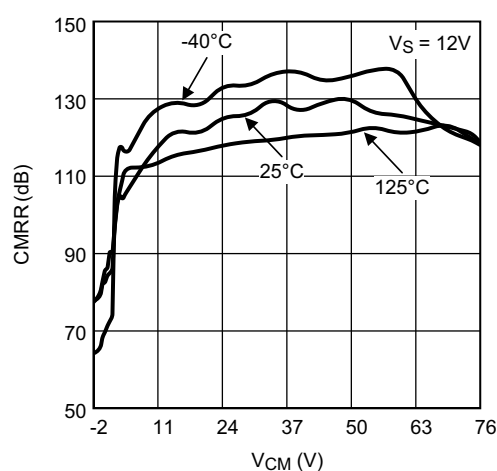


图 6-6. CMRR vs.  $V_{\text{CM}}$

## 6.8 Typical Characteristics (continued)

Unless otherwise specified:  $T_A = 25^\circ\text{C}$ ,  $V_S = V^+ - V^-$ ,  $V_{\text{SENSE}} = +\text{IN} - (-\text{IN})$ ,  $R_L = 10\text{ M}\Omega$ .

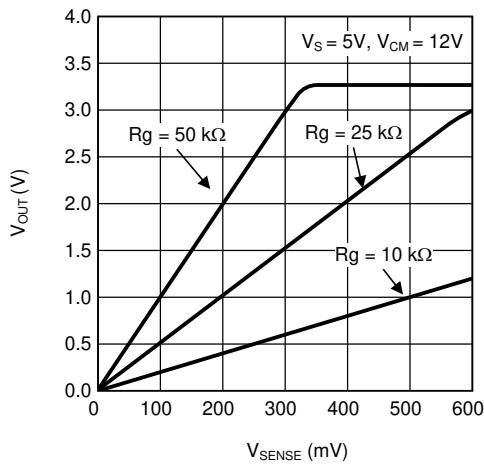


图 6-7. Output Voltage vs.  $V_{\text{SENSE}}$

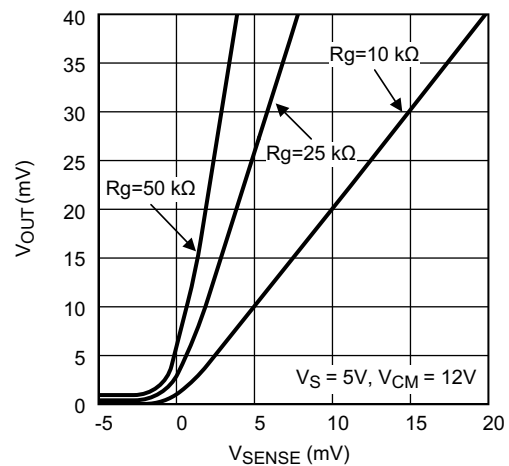


图 6-8. Output Voltage vs.  $V_{\text{SENSE}}$  (ZOOM Close to 0 V)

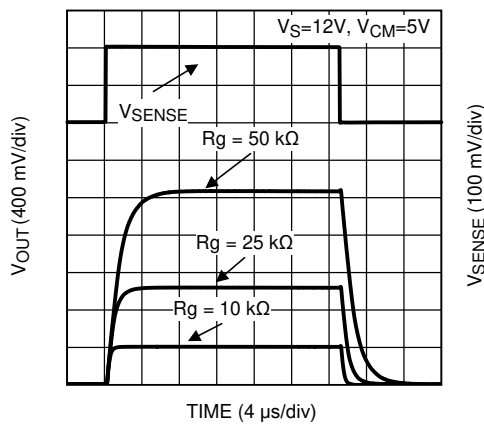


图 6-9. Large Step Response

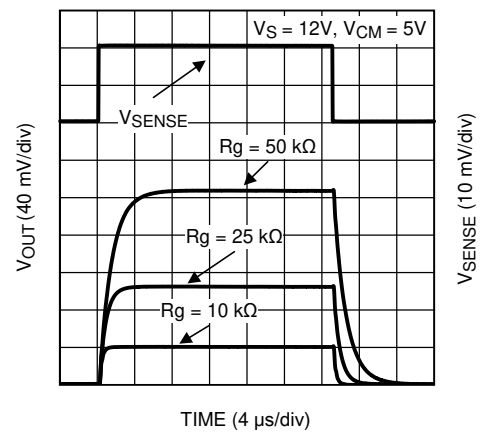


图 6-10. Small Step Response

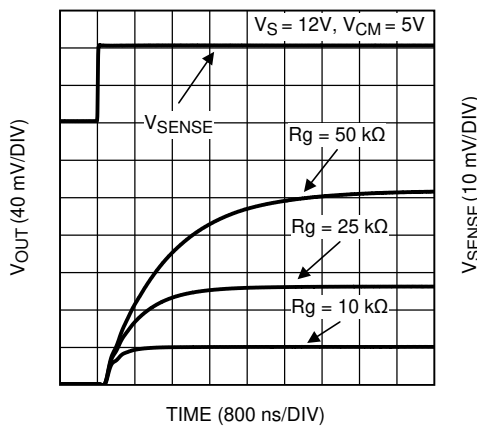


图 6-11. Settling Time (Rise)

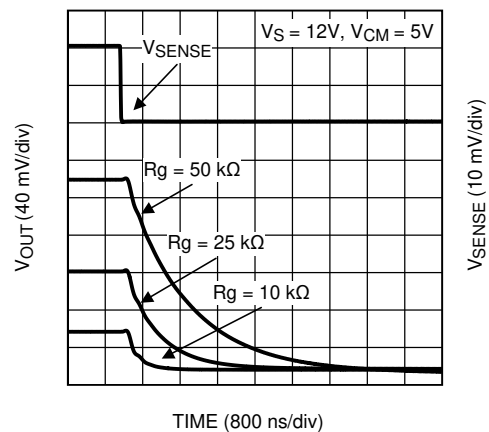


图 6-12. Settling Time (Fall)

## 6.8 Typical Characteristics (continued)

Unless otherwise specified:  $T_A = 25^\circ\text{C}$ ,  $V_S = V^+ - V^-$ ,  $V_{\text{SENSE}} = +\text{IN} - (-\text{IN})$ ,  $R_L = 10\text{ M}\Omega$ .

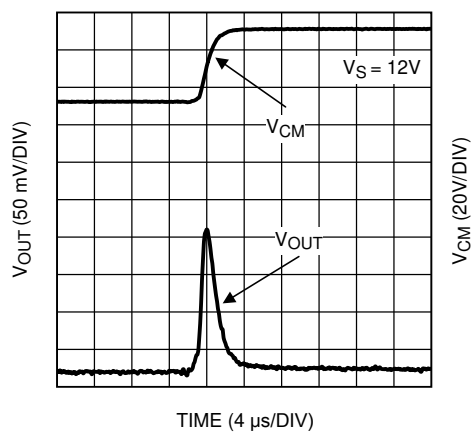


图 6-13. Common-Mode Step Response (Rise)

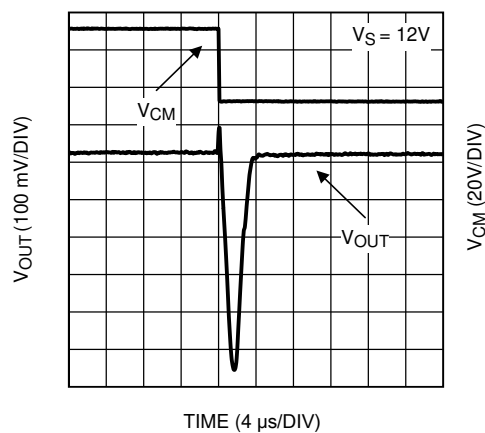


图 6-14. Common-Mode Step Response (Fall)

## 7 Detailed Description

### 7.1 Overview

Operating from a 2.7-V to 12-V supply range, the LMP8645 accepts input signals with a common-mode voltage range of  $-2\text{ V}$  to  $42\text{ V}$ , while the LMP8645HV accepts input signals with a common-mode voltage range of  $-2\text{ V}$  to  $76\text{ V}$ . The LMP8645 and LMP8645HV have adjustable gain, set by a single resistor, for applications where supply current and high common-mode voltage are the determining factors.

#### 7.1.1 Theory of Operation

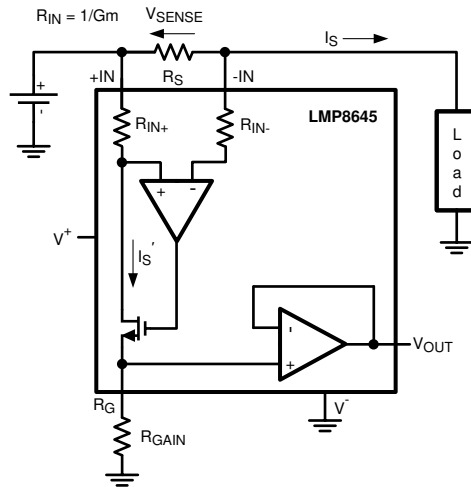


图 7-1. Current Monitor Example Circuit

As seen in 图 7-1, the current flowing through the shunt resistor ( $R_S$ ) develops a voltage drop equal to  $V_{\text{SENSE}}$  across  $R_S$ . The resulting voltage at the  $-IN$  pin will now be less than  $+IN$  pin proportional to the  $V_{\text{SENSE}}$  voltage.

The sense amplifier senses this indifference and increases the gate drive to the MOSFET to increase  $I_S'$  current flowing through the  $R_{\text{IN}+}$  string until the amplifier inputs are equal. In this way, the voltage drop across  $R_{\text{IN}+}$  now matches the voltage drop across  $V_{\text{SENSE}}$ .

The  $R_{\text{IN}}$  resistors are trimmed to a nominal value of  $5\text{ k}\Omega$  each. The current  $I_S'$  flows through  $R_{\text{IN}+}$ , the MOSFET, and  $R_{\text{GAIN}}$  to ground. The  $I_S'$  current generates the voltage  $V_G$  across  $R_{\text{GAIN}}$ . The gain is created by the ratio of  $R_{\text{GAIN}}$  and  $R_{\text{IN}}$ .

A current proportional to  $I_S$  is generated according to the following relation:

$$I_S' = V_{\text{SENSE}} / R_{\text{IN}} = R_S \times I_S / R_{\text{IN}} \quad (1)$$

where

- $R_{\text{IN}} = 1 / G_m$

This current flows entirely in the external gain resistor developing a voltage drop equal to:

$$V_G = I_S' \times R_{\text{GAIN}} = (V_{\text{SENSE}} / R_{\text{IN}}) \times R_{\text{GAIN}} = (R_S \times I_S) / R_{\text{IN}} \times R_{\text{GAIN}} \quad (2)$$

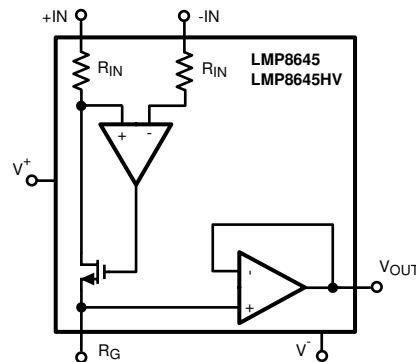
This voltage is buffered and presented at the output with a very low output impedance allowing a very easy interface to other devices (ADC,  $\mu\text{C}$ ...).

$$V_{\text{OUT}} = (R_S \times I_S) \times G \quad (3)$$

where

- $G = R_{\text{GAIN}} / R_{\text{IN}}$

## 7.2 Functional Block Diagram



## 7.3 Feature Description

### 7.3.1 Driving ADC

The input stage of an Analog-to-Digital converter can be modeled with a resistor and a capacitance versus ground. So if the voltage source does not have a low impedance, an error in the measurement of the amplitude will occur. In this condition a buffer is needed to drive the ADC. The LMP8645 has an internal output buffer able to drive a capacitance load up to 30 pF or the input stage of an ADC. If required an external lowpass RC filter can be added at the output of the LMP8645 to reduce the noise and the bandwidth of the current sense. Any other filter solution that implies a capacitance connected to the  $R_G$  pin is not suggested due to the high impedance of that pin.

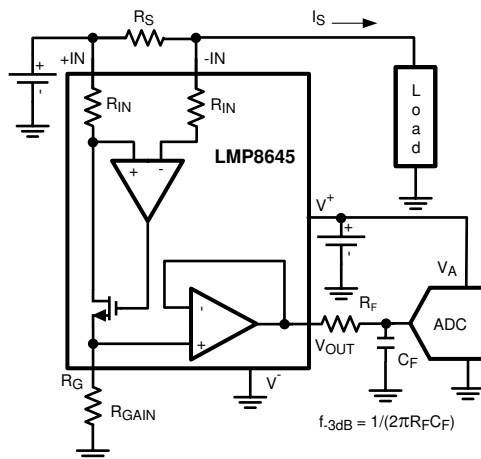


图 7-2. LMP8645 to ADC Interface

### 7.3.2 Applying Input Voltage With No Supply Voltage

The full specified input common-mode voltage range may be applied to the inputs while the LMP8645 power is off ( $V+ = 0$  V). When the LMP8640 is powered off, the  $R_{IN}$  resistors are disconnected internally by MOSFETS and the leakage currents are very low (sub  $\mu$ A).

The 6-V input differential limit still applies, so at no time should the two inputs be more than 6-V apart. There are also Zener clamps on the inputs to ground, so do not exceed the input limits specified in the [Absolute Maximum Ratings](#).

## 7.4 Device Functional Modes

### 7.4.1 Selection of the Gain Resistor

For the LMP8645 and LMP8645HV, the gain is selected through an external gain set resistor connected to the  $R_G$  pin. Moreover, the gain resistor  $R_{GAIN}$  determines the voltage of the output buffer, which is related to the supply voltage and also to the common-mode voltage of the input signal.

### 7.4.2 Gain Range Limitations

The gain resistor must be chosen such that the theoretical maximum output voltage does not exceed the LMP8645 maximum output voltage rating for a given common-mode voltage. These limits are due to the internal amplifier bias point and the  $V_{CM}$  headroom required to generate the required currents across the  $R_{IN}$  and  $R_{GAIN}$  resistors.

The following sections explain how to select the gain resistor for various ranges of the input common-mode voltage.

#### 7.4.2.1 Range 1: $V_{CM}$ is -2 V to 1.8 V

The maximum voltage at the  $R_G$  pin is given by the following inequality:

$$V_{RG} = V_{sense} \times R_{GAIN} \times G_m \leq \min(1.3 \text{ V}; V_{out\_max}) \quad (4)$$

where

- $V_{out\_max}$  is the maximum allowable output voltage according to the Electrical Tables

All the gain resistors ( $R_{GAIN}$ ) values which respect the previous inequality are allowed. The graphical representation of 图 7-3 helps in the selection.

All the combinations ( $V_{SENSE}$ ,  $R_{GAIN}$ ) below the curve are allowed.

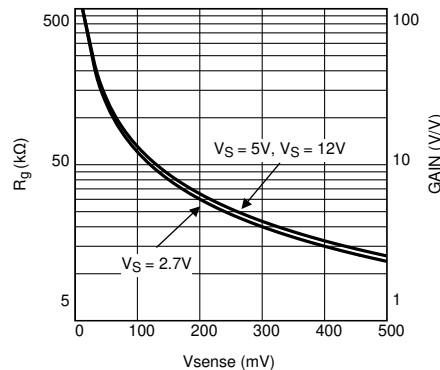


图 7-3. Allowed Gains for Range 1

As a consequence, once selected, the gain ( $R_{GAIN}$ ) and the  $V_{SENSE}$  range is fixed, too.

For example if an application required a Gain of 10,  $R_G$  will be 50 kΩ and  $V_{SENSE}$  will be in the range 10 mV to 100 mV.

#### 7.4.2.2 Range 2: $V_{CM}$ is 1.8 V to $V_S$

In this range, the maximum voltage at the  $R_G$  pin is related to the common-mode voltage and  $V_{SENSE}$ . So all the  $R_{GAIN}$  resistor values which respect the following inequalities are allowed:

$$V_{RG} \leq \min(V_{out\_max}; (V_{CM} - V_{sense} - 250 \text{ mV})) \quad (5)$$

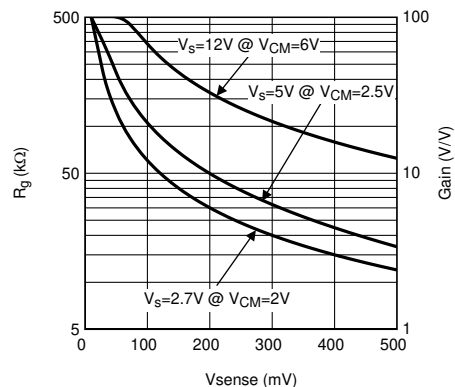
where

- $V_{RG} = V_{SENSE} \times R_{GAIN} \times G_m$

- $V_{out\_max}$  is the maximum allowable output voltage according to the [2.7-V Electrical Characteristics](#), [5-V Electrical Characteristics](#), and [12-V Electrical Characteristics](#).

The graphical representation in [图 7-4](#) helps in the selection.

All the combinations ( $V_{SENSE}$ ,  $R_{GAIN}$ ) below the curves for given  $V_{CM}$  and supply voltage are allowed.



**图 7-4. Allowed Gains for Range 2**

Also in this range, once selected, the  $R_{GAIN}$  (Gain) and the  $V_{SENSE}$  range is fixed too.

### 7.4.2.3 Range 3: $V_{CM}$ is greater than $V_S$

The maximum voltage at the  $R_G$  pin is  $V_{out\_max}$ , it means that:

$$V_{OUT} = V_{SENSE} \times R_{GAIN} / R_{IN} \leq V_{out\_max} \quad (6)$$

where

- $V_{out\_max}$  is the maximum allowable output voltage according to the Electrical Tables

So all the  $R_{GAIN}$  resistors which respect the previous inequality are allowed. The graphical representation in [图 7-5](#) helps with the selection.

All the combinations ( $V_{SENSE}$ ,  $R_{GAIN}$ ) below the curves are allowed.

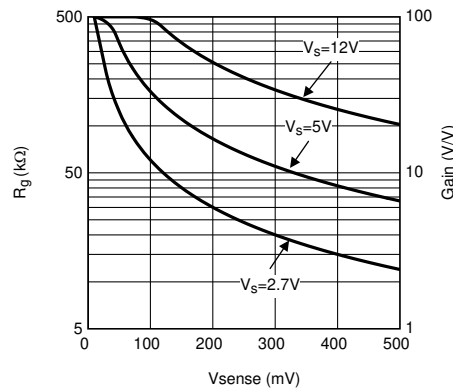


图 7-5. Allowed Gains for Range 3

Also in this range once selected the  $R_{GAIN}$  (Gain) the  $V_{SENSE}$  range is fixed too.

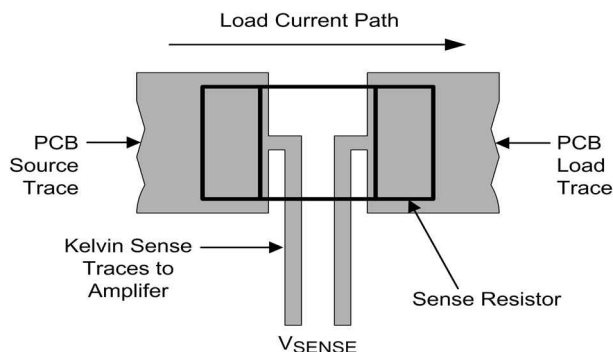
From the ranges shown above, a good way to maximize the output voltage swing of the LMP8645 is to select the maximum allowable  $R_{GAIN}$  according to the previous equations. For a fixed supply voltage and  $V_{SENSE}$  as the common-mode voltage increases, the maximum allowable  $R_{GAIN}$  increases too.

### 7.4.3 Selection of Sense Resistor

The accuracy of the current measurement highly depends on the value of the shunt resistor  $R_S$ . Its value depends on the application and it is a compromise between small-signal accuracy and maximum permissible voltage (and power) loss in the sense resistor. High values of  $R_S$  provide better accuracy at lower currents by minimizing the effects of amplifier offset. Low values of  $R_S$  minimize voltage and power loss in the supply section, but at the expense of low current accuracy. For most applications, best performance is obtained with an  $R_S$  value that provides a full-scale shunt voltage range of 100 mV to 200 mV.

In applications where a small current is sensed, a larger value of  $R_S$  is selected to minimize the error in the proportional output voltage. Higher resistor value improves the signal-to-noise ratio (SNR) at the input of the current sense amplifier and hence gives a more accurate output.

Similarly when high current is sensed, the power losses in  $R_S$  can be significant so a smaller value of  $R_S$  is desired. In this condition it is also required to take in account also the power rating of  $R_S$  resistor. The low input offset and customizable gain of the LMP8645 allows the use of small sense resistors to reduce power dissipation still providing a good input dynamic range. The input dynamic range is the ratio between the maximum signal that can be measured and the minimum signal that can be detected, where usually the input offset and amplifier noise are the principal limiting factors.



**图 7-6. Example of a Kelvin (4-Wire) Connection to a Two-Terminal Resistor**

The amplifier inputs should be directly connected to the sense resistor pads using *Kelvin* or *4-wire* connection techniques. The paths of the input traces should be identical, including connectors and vias, so that these errors will be equal and cancel.

#### 7.4.3.1 Resistor Power Rating and Thermal Issues

The power dissipated by the sense resistor can be calculated from:

$$P_D = I_{MAX}^2 * R_S \quad (7)$$

where

- $P_D$  is the power dissipated by the resistor in Watts
- $I_{MAX}$  is the maximum load current in A
- $R_S$  is the sense resistor value in  $\Omega$ .

The resistor must be rated for more than the expected maximum power ( $P_D$ ), with margin for temperature derating. Be sure to observe any power derating curves provided by the resistor manufacturer.

Running the resistor at higher temperatures will also affect the accuracy. As the resistor heats up, the resistance generally goes up, which will cause a change in the measurement. The sense resistor should have as much heat-sinking as possible to remove this heat through the use of heatsinks or large copper areas coupled to the resistor pads. A reading drifting slightly after turnon can usually be traced back to sense resistor heating.

#### 7.4.3.2 Using PCB Trace as a Sense Resistor

While it may be tempting to use the resistance of a known area of PCB trace or copper area as a sense resistor, TI does not recommend this for precision measurements.

The tempco of copper is typically 3300 to 4000 ppm/°K (0.33% to 0.4% per °C), which can vary with PCB processes.

A typical surface mount sense resistor temperature coefficient (tempco) is in the 50 ppm to 500 ppm per °C range offering more measurement consistency and accuracy over the copper trace. Special low tempco resistors are available in a range from 0.1 ppm to 50 ppm, but at a much higher cost.

#### 7.4.4 Sense Line Inputs

The sense lines should be connected to a point on the resistor that is not shared with the main current path, as shown in 图 7-6. For lowest drift, the amplifier must be mounted away from any heat generating devices, which may include the sense resistor. The traces should be one continuous trace of copper from the sense resistor pad to the amplifier input pin pad, and ideally on the same copper layer with minimal vias or connectors. This can be important around the sense resistor if it is generating any significant heat gradients. Vias in the sense lines should be formed from continuous plated copper and routing through mating connectors or headers should be avoided. It is better to extend the sense lines than to place the amplifier in a hostile environment.

To minimize noise pickup and thermal errors, the input traces should be treated like a high-speed differential signal pair and routed tightly together with a direct path to the input pins on the same copper layer. They do not need to be *impedance matched*, but should follow the same matching rules about vias, spacing and equal lengths. The input traces should be run away from noise sources, such as digital lines, switching supplies, or motor drive lines.

Remember that these input traces can contain high voltage (up to 76 V), and should have the appropriate trace routing clearances to other components, traces and layers. Because the sense traces only carry the amplifier bias current, the connecting input traces can be thin traces running close together. This can help with routing or creating the required spacings.

---

#### 备注

Due to the nature of the device topology, the positive input bias current will vary with  $V_{\text{SENSE}}$  with an extra current approximately equivalent to  $V_{\text{SENSE}} / 5 \text{ k}\Omega$  on top of the typical 12  $\mu\text{A}$  bias current.

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The negative input bias current is not in the feedback path and will not change over  $V_{\text{SENSE}}$ . High or mismatched source impedances should be avoided as this imbalance will create an additional error term over input voltage.

#### 7.4.4.1 Effects of Series Resistance on Sense Lines

While the sense amplifier is depicted as a conventional operational amplifier, it really is based on a current-differencing topology. The input stage uses precision 5-k $\Omega$  resistors internally to convert the voltage on the input pin onto a current, so any resistance added in series with the input pins will change this resistance, and thus the resulting current, causing an error. TI recommends that the total path resistance be less than 10  $\Omega$  and equal to both inputs.

If a resistance is added in series with an input, the gain of that input will not track that of the other input, causing a constant gain error.

TI does not recommend using external resistance to alter the gain, as external resistors do not have the same thermal matching and tracking as the internal thin film resistors. Any added resistance will severely degrade the offset and CMRR specifications.

If resistors are purposely added for filtering, resistance should be added equally to both inputs and be less than 10  $\Omega$ , and the user should be aware that the gain will change slightly.

## 8 Application and Implementation

### 备注

以下应用部分中的信息不属于 TI 器件规格的范围，TI 不担保其准确性和完整性。TI 的客户应负责确定器件是否适用于其应用。客户应验证并测试其设计，以确保系统功能。

### 8.1 Application Information

The LMP8645 device measures the small voltage developed across a current-sensing resistor when current passes through it in the presence of high common-mode voltage. The gain is set by a single resistor and buffered to a single-ended output.

### 8.2 Typical Applications

#### 8.2.1 Typical Current Monitor Application

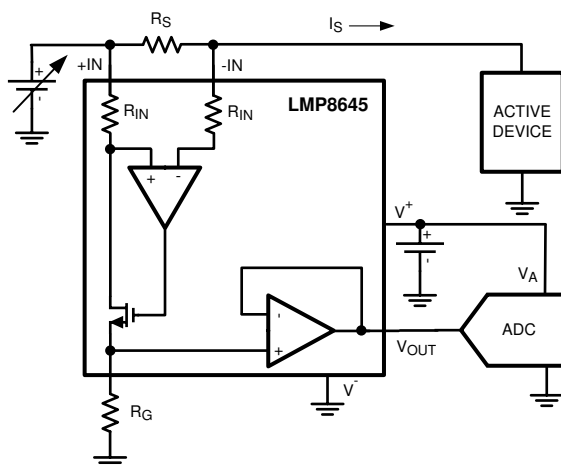


图 8-1. LMP8645 in Current Monitor Application

##### 8.2.1.1 Design Requirements

In this example, the LMP8645 is used to monitor the supply current of an active device (Refer to 图 8-1). The LMP8645 supply voltage is 5 V and the active device is supplied with 12 V. The maximum load current is 1 A.

The LMP8645 will operate in all 3 ranges: in [Range 1](#) when turning on the power of the active device (rising from 0 V to 12 V), while briefly passing through [Range 2](#) as the load supply rises, and finally into [Range 3](#) for normal load operation.

Because the purpose of the application is monitor the current of the active device in any operating condition (power on, normal operation, fault, and so forth), the gain resistor will be selected according to [Range 1](#), the range that puts the most constraints to the maximum output voltage swing of the LMP8645.

##### 8.2.1.2 Detailed Design Procedure

At the start-up of the monitored device, the LMP8645 works at a common-mode voltage of 0 V, which means that the maximum output limit is 1.3 V (Range 1). To maximize the resolution, the  $R_{SENSE}$  value is calculated as maximum allowed  $V_{SENSE}$  (Refer to 图 7-3) divided by maximum current (1 A), so  $R_{SENSE}=0.5\ \Omega$ .

Due to the output limitation at low common-mode voltage, the maximum allowed gain will be 2.6 V/V, which corresponds to  $R_{GAIN} = 13\ k\Omega$ . With this approach the current is monitored correctly at any working condition, but does not use the full output swing range of the LMP8645.

Alternatively if the monitored device doesn't sink the full 1 A at any supply voltage, it is possible to design with the full maximum output voltage of the LMP8645 when operating in Range 3 ( $V_{CM} \geq V_S$ ).

Also in this case it is possible to maximize the resolution using  $R_{sense} = 0.5 \Omega$ , and maximize the output dynamic range with  $R_{GAIN} = 33 \text{ k}\Omega$ . With this approach the maximum detectable current, when  $V_{CM}$  is less than 1.8 V, is about 400 mA. While for common-mode voltages of less than 2.5 V the maximum detectable current is 600 mA (Refer to Figure 7-3), and for common-mode voltages at or above the LMP8645 supply voltage, the maximum current is 1 A.

The second approach maximizes the output dynamic but implies some knowledge on the monitored current.

### 8.2.1.3 Application Curves

Figure 8-2 shows the resulting circuit voltages with the input load swept from 0 A to 1 A, with  $R_{GAIN} = 13 \text{ k}\Omega$  for operation in Range 1 (preferring accuracy over all load operating conditions).

Also shown in Figure 8-3 is the resulting output voltage with  $R_{GAIN} = 33 \text{ k}\Omega$  for operation in Range 3 (sacrificing low load supply accuracy while optimizing overall resolution at *normal* load operating conditions).

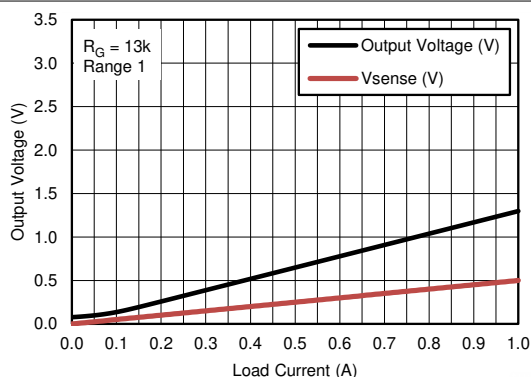


图 8-2. Resulting Input and Output Voltages vs Load Current for Range 1

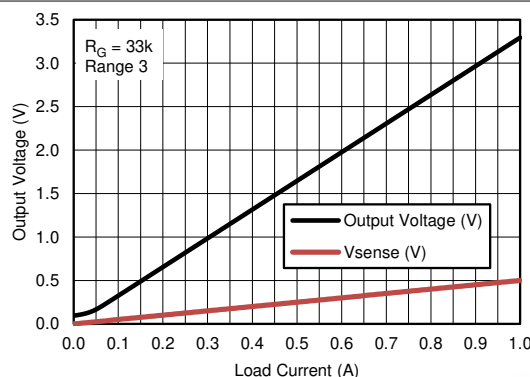


图 8-3. Resulting Input and Output Voltages vs Load Current For Range 3

## 8.2.2 High Brightness LED Driver

The LMP8645 is the right choice in applications which require high-side current sense, such as High Brightness LED for automotive where the cathode of the LED must be connected to the ground (chassis) of the car. In Figure 8-4, the LMP8645 is used to monitor the current High Side in a high brightness LED together with a LM3406 constant current buck regulator LED driver.

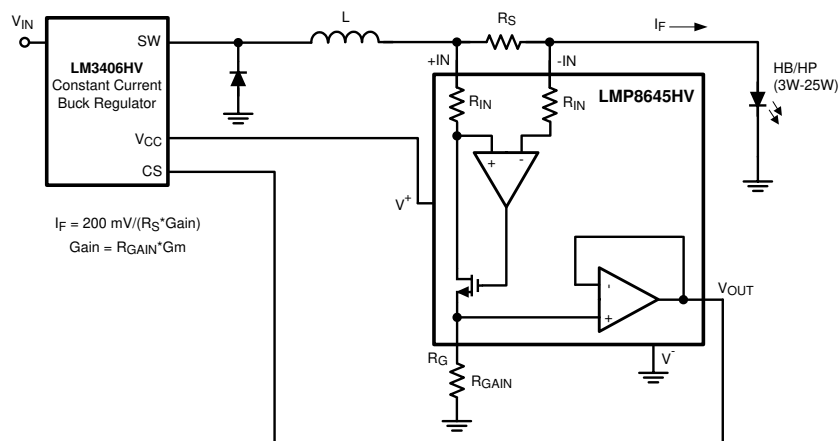


图 8-4. High-Side Current Sensing in Driving HP/HB LED

Even though LMP8645 will work in all 3 Ranges,  $R_{GAIN}$  will be calculated according to Range 3 because the purpose is regulating the current in the LEDs when the external MOSFET is OFF (LMP8645 at high  $V_{CM}$ ). Even

if this approach makes the LMP8645 able to sense high peak current only in Range 3 where the dynamic output is higher than Range 1 the current resolution is maximized. At each switch ON/OFF of the MOSFET the LMP8645 goes from Range 1 (MOSFET ON, string of LED OFF), to Range 3 (MOSFET OFF, string of LED ON) passing through Range 2 (MOSFET OFF, string of LED OFF). Because the purpose of the application is to sense the current with high precision when the LED string is ON, the  $R_{GAIN}$  will be calculated according to the Range 3.

The LMP8645 supply voltage is supplied by the internal LDO of the LM3406 thorough the pin VCC. The LM340x is expecting a 200-mV feedback signal at the current sense (SNS) pin. The LMP8645 must provide this 200 mV at the determined current limit.

The current which flows through the LED is programmed according to [方程式 8](#):

$$I_F = V_{CS} / (R_S \times \text{Gain}) \quad (8)$$

where:

- $\text{Gain} = R_{GAIN} \times G_m$
- $V_{CS} = 200 \text{ mV}$

In this application the current which flows in the HB LED is in the Range from 350 mA to 1 A, so to reduce the power dissipation on the shunt resistor and have a good accuracy, the  $R_S$  must be in the range from 50 mΩ and 200 mΩ. In [表 8-1](#), two examples are analyzed.

To summarize, calculate the  $R_{GAIN}$  according to the range of operation in which the application mainly works. Once selected, the range considers the more stringent constraint

**表 8-1. Comparison of Two Ranges**

|                         | $I_F=350 \text{ mA}$ | $I_F=1 \text{ A}$ |
|-------------------------|----------------------|-------------------|
| $R_{GAIN}$              | 40 kΩ                | 36 kΩ             |
| $R_S$                   | 77 mΩ                | 27 mΩ             |
| <b>Dissipated Power</b> | 9.5 mW               | 27 mW             |
| <b>Total Accuracy</b>   | ≈5%                  | ≈5%               |

## 9 Power Supply Recommendations

To decouple the LMP8645 from AC noise on the power supply, TI recommends using a 0.1- μ F bypass capacitor between the  $V_S$  and GND pins. This capacitor must be placed as close as possible to the supply pins. In some cases, an additional 10- μ F bypass capacitor may further reduce the supply noise.

## 10 Layout

### 10.1 Layout Guidelines

The traces leading to and from the sense resistor can be significant error sources. With small value sense resistors ( $< 100 \text{ m}\Omega$ ), any trace resistance shared with the load current can cause significant errors.

The amplifier inputs should be directly connected to the sense resistor pads using *Kelvin* or *4-wire* connection techniques. The traces should be one continuous piece of copper from the sense resistor pad to the amplifier input pin pad, and ideally on the same copper layer with minimal vias or connectors. This can be important around the sense resistor if it is generating any significant heat gradients.

To minimize noise pick-up and thermal errors, the input traces should be treated like a differential signal pair and routed tightly together with a direct path to the input pins (preferably on the same copper layer). The input traces should be run away from noise sources, such as digital lines, switching supplies or motor drive lines.

Ensure that the sense traces have the appropriate trace routing clearances for the expected load supply voltages.

Because the sense traces only carry the amplifier bias current, the connecting input traces can be thinner, signal level traces. Excessive Resistance in the trace should also be avoided.

The paths of the traces should be identical, including connectors and vias, so that any errors will be equal and cancel.

The sense resistor will heat up as the load increases. As the resistor heats up, the resistance generally goes up, which will cause a change in the readings. The sense resistor should have as much heatsinking as possible to remove this heat through the use of heatsinks or large copper areas coupled to the resistor pads.

The gain set resistor pin is a sensitive node and can pick up noise. Keep the gain set resistor close to the RG pin and minimize  $R_{\text{GAIN}}$  trace length. Connect the grounded end of  $R_{\text{GAIN}}$  directly to the LMP8645 ground pin.

### 10.2 Layout Example

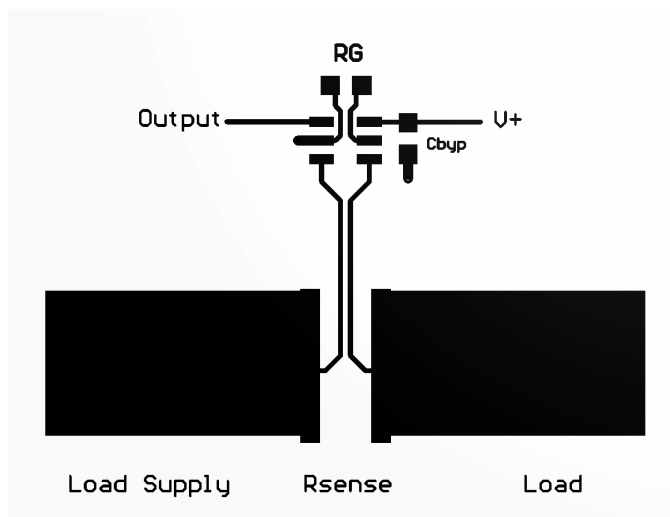


图 10-1. Layout Example

## 11 Device and Documentation Support

### 11.1 Device Support

#### 11.1.1 Development Support

LMP8645 TINA SPICE Model, [SNOM087](#)

TINA-TI SPICE-Based Analog Simulation Program, <http://www.ti.com/tool/tina-ti>

Evaluation Board for the LMP8645, <http://www.ti.com/tool/imp8645mkeval>

### 11.2 Documentation Support

#### 11.2.1 Related Documentation

For related documentation, see the following:

*AN-1975 LMP8640 / LMP8645 Evaluation Board User Guide*, [SNOA546](#)

### 11.3 接收文档更新通知

要接收文档更新通知，请导航至 [ti.com](http://ti.com) 上的器件产品文件夹。点击 [订阅更新](#) 进行注册，即可每周接收产品信息更改摘要。有关更改的详细信息，请查看任何已修订文档中包含的修订历史记录。

### 11.4 支持资源

[TI E2E™ 支持论坛](#) 是工程师的重要参考资料，可直接从专家获得快速、经过验证的解答和设计帮助。搜索现有解答或提出自己的问题可获得所需的快速设计帮助。

链接的内容由各个贡献者“按原样”提供。这些内容并不构成 TI 技术规范，并且不一定反映 TI 的观点；请参阅 TI 的《使用条款》。

### 11.5 Trademarks

TI E2E™ is a trademark of Texas Instruments.

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### 11.6 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 11.7 术语表

[TI 术语表](#) 本术语表列出并解释了术语、首字母缩略词和定义。

## 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable Device  | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|-------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| LMP8645HVMK/NOPB  | ACTIVE        | SOT-23-THIN  | DDC                | 6    | 1000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AK6A                    | <a href="#">Samples</a> |
| LMP8645HVMKE/NOPB | ACTIVE        | SOT-23-THIN  | DDC                | 6    | 250            | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AK6A                    | <a href="#">Samples</a> |
| LMP8645HVMKX/NOPB | ACTIVE        | SOT-23-THIN  | DDC                | 6    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AK6A                    | <a href="#">Samples</a> |
| LMP8645MK/NOPB    | ACTIVE        | SOT-23-THIN  | DDC                | 6    | 1000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AJ6A                    | <a href="#">Samples</a> |
| LMP8645MKE/NOPB   | ACTIVE        | SOT-23-THIN  | DDC                | 6    | 250            | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AJ6A                    | <a href="#">Samples</a> |
| LMP8645MKX/NOPB   | ACTIVE        | SOT-23-THIN  | DDC                | 6    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AJ6A                    | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| LMP8645HVMK/NOPB  | SOT-23-THIN  | DDC             | 6    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LMP8645HVMKE/NOPB | SOT-23-THIN  | DDC             | 6    | 250  | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LMP8645HVMKX/NOPB | SOT-23-THIN  | DDC             | 6    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LMP8645MK/NOPB    | SOT-23-THIN  | DDC             | 6    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LMP8645MKE/NOPB   | SOT-23-THIN  | DDC             | 6    | 250  | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LMP8645MKX/NOPB   | SOT-23-THIN  | DDC             | 6    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| LMP8645HVMK/NOPB  | SOT-23-THIN  | DDC             | 6    | 1000 | 208.0       | 191.0      | 35.0        |
| LMP8645HVMKE/NOPB | SOT-23-THIN  | DDC             | 6    | 250  | 208.0       | 191.0      | 35.0        |
| LMP8645HVMKX/NOPB | SOT-23-THIN  | DDC             | 6    | 3000 | 208.0       | 191.0      | 35.0        |
| LMP8645MK/NOPB    | SOT-23-THIN  | DDC             | 6    | 1000 | 208.0       | 191.0      | 35.0        |
| LMP8645MKE/NOPB   | SOT-23-THIN  | DDC             | 6    | 250  | 208.0       | 191.0      | 35.0        |
| LMP8645MKX/NOPB   | SOT-23-THIN  | DDC             | 6    | 3000 | 208.0       | 191.0      | 35.0        |



## SOT-23 - 1.1 max height

## SMALL OUTLINE TRANSISTOR



4214841/D 06/2024

NOTES:

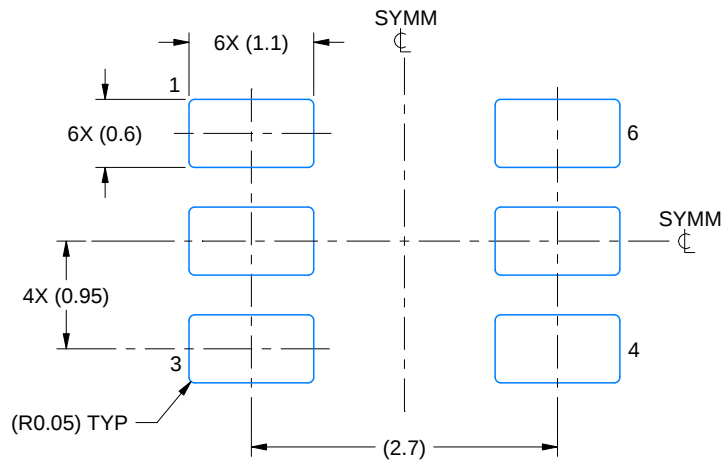
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC MO-193.

# EXAMPLE BOARD LAYOUT

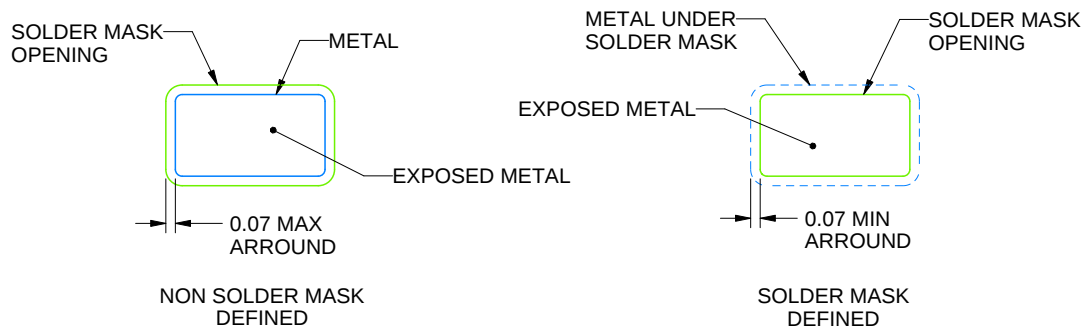
DDC0006A

SOT-23 - 1.1 max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
EXPLODED METAL SHOWN  
SCALE:15X

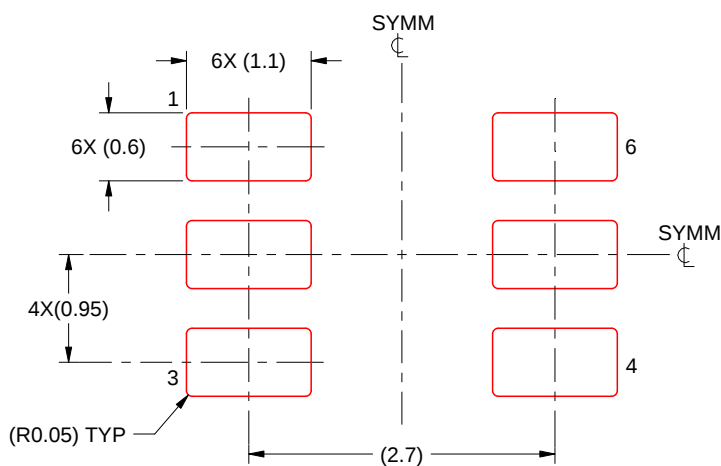


SOLDERMASK DETAILS

4214841/D 06/2024

NOTES: (continued)

4. Publication IPC-7351 may have alternate designs.
5. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOLDER PASTE EXAMPLE  
BASED ON 0.125 THICK STENCIL  
SCALE:15X

4214841/D 06/2024

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
7. Board assembly site may have different recommendations for stencil design.

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